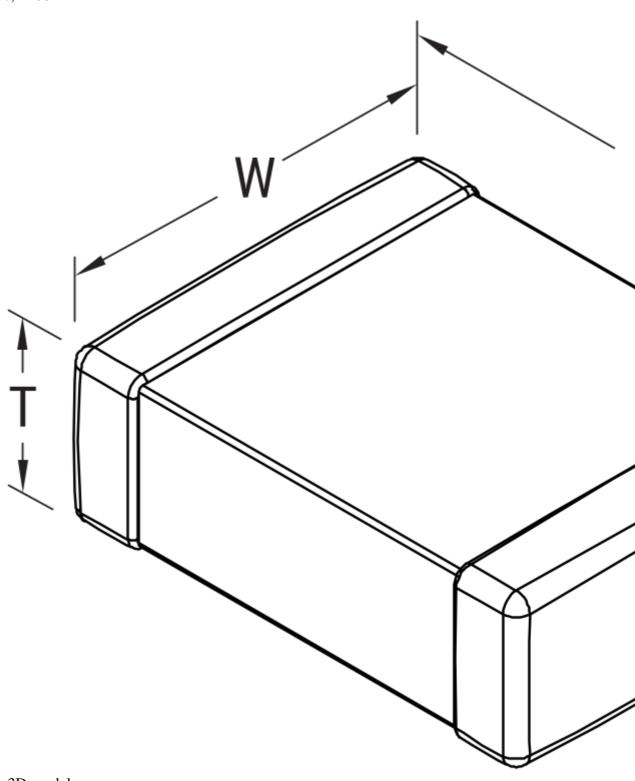
## C1206S103K2RACAUTO

SMD Auto X7R FE, Ceramic, 0.01 uF, 10%, 200 VDC, X7R, SMD, MLCC, FE-CAP, Floating Electrode, Automotive Grade, 1206



Click here for the 3D model.

## **Dimensions**

Chip Size 1206

 $\begin{array}{lll} L & 3.2mm + \!\!\!\!\!\!\!/ -0.2mm \\ W & 1.6mm + \!\!\!\!\!\!\!\!\!/ -0.2mm \\ T & 0.78mm + \!\!\!\!\!\!\!/ -0.10mm \end{array}$ 

### **Dimensions**

B 0.5mm +/-0.25mm

## **Packaging Specifications**

Packaging T&R, 180mm, Plastic Tape

Packaging Quantity 4000

### **General Information**

Series SMD Auto X7R FE

Style SMD Chip

Description SMD, MLCC, FE-CAP, Floating Electrode, Automotive Grade

Features FE-CAP, Floating Electrode, Automotive Grade

RoHS Yes
Termination Tin
Marking No

Qualifications AEC-Q200

AEC-Q200 Yes Component Weight 17 mg Shelf Life 78 Weeks

MSL 1

## **Specifications**

Capacitance 0.01 uF

Measurement Condition 1 kHz 1.0Vrms

Capacitance Tolerance 10%

Voltage DC 200 VDC
Dielectric Withstanding Voltage 500 VDC
Temperature Range -55/+125°C

Temperature Coefficient X7R

Capacitance Change with Reference to +25°C and 0

VDC Applied (TCC)

Dissipation Factor 2.5% 1 kHz 1.0Vrms

2.5 % 1 KHZ 1.0 VIIIIS

Aging Rate 3% Loss/Decade Hour: Referee Time

is 1000 Hours

15%, 1kHz 1.0Vrms

Insulation Resistance 100 GOhms

Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute - and we specifically disclaim - any warranty concerning suitability for a specific customer application or use. This Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.

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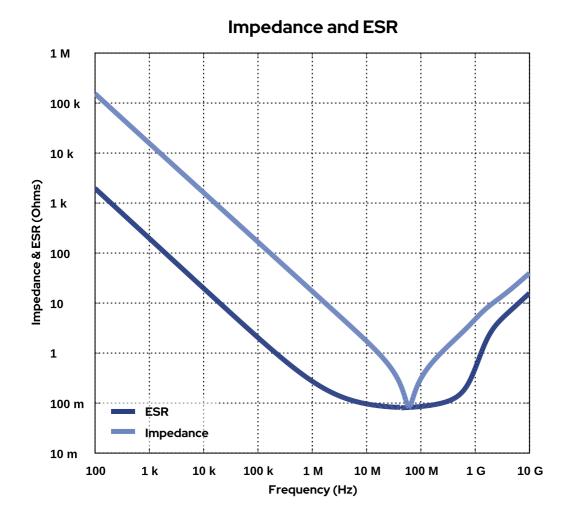
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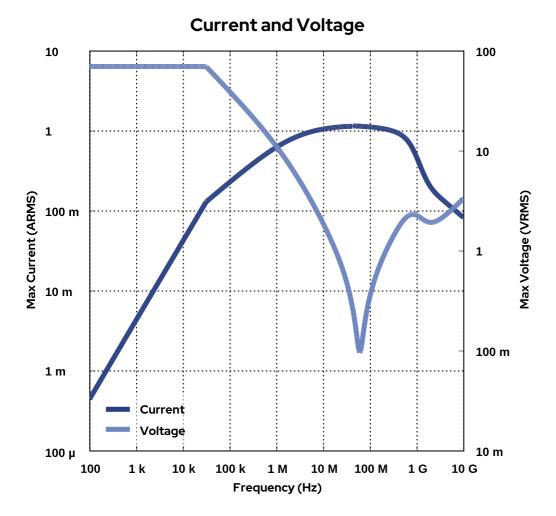
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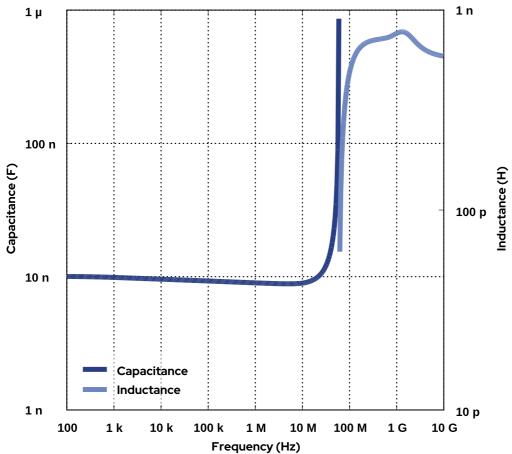
# **Simulations**

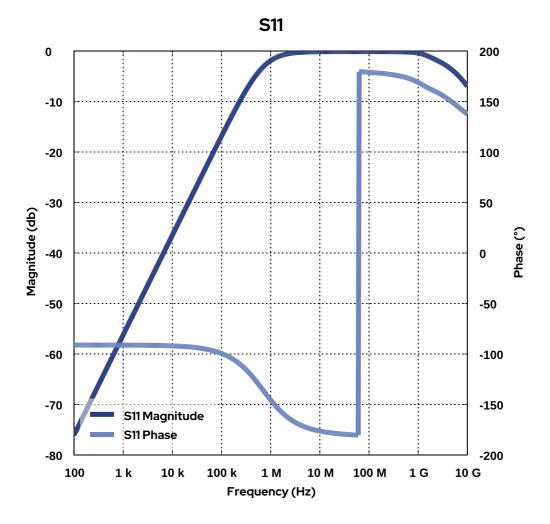
For the complete simulation environment please visit **K-SIM**.



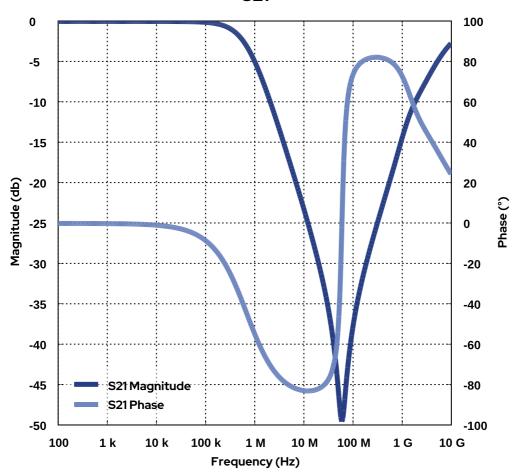


# Capacitance and Inductance

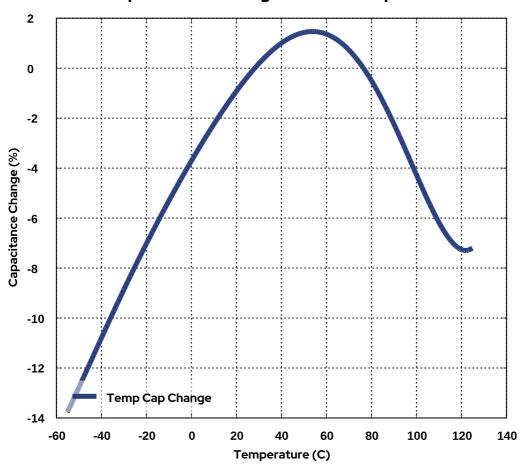




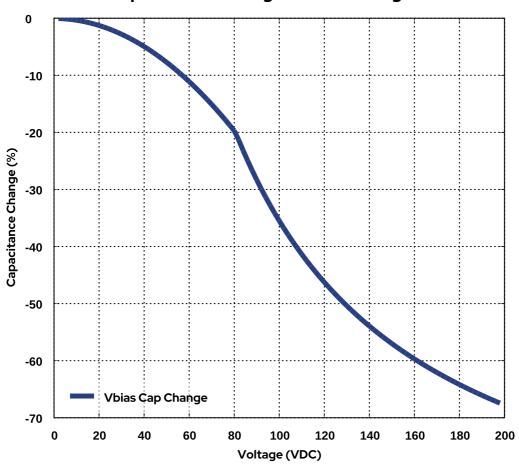




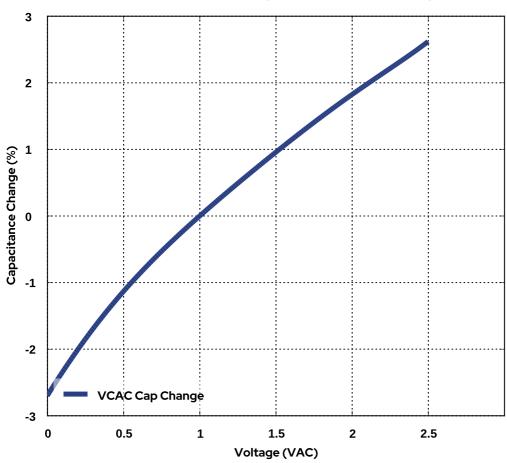
## Capacitance Change versus Temperature



## Capacitance Change vs. DC Voltage Bias







### These are simulations.

This is not a specification!

The responses shown represent the typical response for each part type. Specific responses may vary, depending on manufacturing variation affects of all parameters involved, including the specified tolerances applied to capacitance and unspecified variations of ESR, ESL, and leakage resistance.

The responses shown do not represent a specified or implied maximum capability of the device for all applications.

- The ESR used for ripple "Ripple Current/Voltage vs. Frequency" plots is the ESR at ambient temperature.
- The ESR in the "Temperature Rise vs. Ripple Current" plots is adjusted to each incremental temperature rise before the power and ripple current is calculated.
- The effects shown herein are based on measured data from a multiple part sample of the parts in question.
- Ripple capability of this device will be factored by thermal resistance (Rth) created by circuit traces (addi affects of all parameters involved, including the specified tolerances applied to capacitance and unspecified variations of ESR, ESL, and leakage resistance.
- The peak voltages generated in the "Temperature Rise vs. Combined Ripple Currents" plot are

- calculated for each frequency and are not combined with voltages generated at any other harmonics.
- Please consult with the catalog or field applications engineer for maximum capability of the device in specific applications.

All product information and data (collectively, the "Information") are subject to change without notice.

KEMET K-SIM is designed to simulate behavior of components with respect to frequency, ambient temperature, and DC bias levels. The responses shown represent the typical response for each part type. Specific responses may vary, depending on manufacturing variation effects of all parameters involved, including the specified tolerances applied to capacitance and unspecified variations of ESR, ESL, and leakage resistance.

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If you have any questions please contact K-SIM.